APPLICA		NDARD							
Operating Temperature F		Range	-55°C to 125°C(Notes	1)	Storage Temperature Range		-10°C TO 60°C		
RATING	Voltage Current				Mating Connector		DF40TC-30DP-0. 4V)
	1		SPECIFIC	CATI	ONS	•			
TI	EM		TEST METHOD			REQL	JIREMENTS	QT	AT
CONSTR								ΙX	X
General Examination			Visually and by measuring instrument.			According to drawing.			
Marking. ELECTRIC CHARA			CTEDISTICS					X	X
Contact Resistance			C or less 1khz, 1mA.	1 90	OmΩ MAX.		X		
Insulation Resistance		100V DC	100V DC.			50MΩ MIN.			+
Voltage Proof		100V AC	100V AC for 1 min.			No flashover or breakdown.			+-
			ERISTICS					X	
Mechanical (insertions and extractions.		① C	ontact resista	nce: 90mΩ MAX.		T
Micorianical	wechanical Operation					No damage, crack or looseness of parts.			
Vibration		Sweep ti	Frequency 10 to 500, acceleration 49 m/s ^{2.,} Sweep time 1 oct/min. 8h for 3 axial directions.			o electrical disc	discontinuity of 1 μs.		-
Shock		Accelera	Acceleration 980 m/s², duration of pulse 6 ms at 3 times for 3 directions.			 No electrical discontinuity of 1 μs. No damage, crack or looseness of parts. 			_
ENVIRO	NMENTA	L CHAR	ACTERISTICS						
Rapid Change of		Tempera	Temperature -55 → 125 °C					X	
Temperature		_	Time 30 → 30 min Under 1000 cycles.			Contact resistance: 90mΩ MAX.			
Dry Heat		Exposed	Exposed at 125 °C, 1,000 h.		_				
Damp Heat			Exposed at 60 ± 2 °C Relative humidity 90 to 95 %, 1000 h.			Contact resistance: 90mΩ MAX. Insulation resistance: 25 MΩ MIN. No damage, crack or looseness of parts.			
Damp Heat, Cyclic		Exposed	Exposed at -10 to 65°C, Relative humidity 90 to 96%, 10cycles, total 240h.						
		10cycles,							_
Sulphur Dioxide			Exposed in 25 PPM for 96h, 40°C, Relative humidity 80%.			① Contact resistance: 180mΩ MAX.			-
Heat Resistance of Soldering		MAX 250 Preheatii 150 to 18 Maximum condition. Recomm Soldering	Recommended temperature profile soldering area MAX 250°C, 220°C for 60 seconds MAX. Preheating area 150 to 180°C 90 to 120 seconds. Maximum twice action is allowed under the same condition. Recommended manual soldering condition Soldering iron temperature 350°C. Soldering time: within 3 seconds.			No deformation of case of excessive looseness of the terminals.			_
Solderability		_	Soldering temperature: $245 \pm 5^{\circ}$ C Duration of immersion: soldering for 3 ± 0.5 seconds.			A new uniform coating of solder shall cover a minimum of 95% of the surface being immersed.		X	_
COUN	Т	DESCRIPTI	ON OF REVISIONS	DE	SIGNED	CHECKED		DA	ATE
4 7		DIS-	DIS-H-00009674		. SATAKE	TS. MIYAZAKI		2021	10623
REMARKS Note1: Include	the temperate	ure risina bv c	rising by current			APPROVED	WR. FUKUCHI	2019	90425
	- F	. 5-, 0				CHECKED	TS. MIYAZAKI		90425
l Inless -4	omuica	ifiad == f-	and refer to 110 C E400 150 C0540			DESIGNED	SJ. WADA		90425 90425
	•		ied, refer to JIS C 5402. IEC 60512. st AT:Assurance Test X:Applicable Test		DRAWIN	FI 0 000440 F			
			PECIFICATION SHEET		RT NO.	DF40TC (4. 0) -30DS-0. 4V (51)			
KS	HIROSE ELECTRIC CO., LTD.				DE NO.			<u>(31)</u>	1/1
	HINUSE EL				UL NO.	CL0684-4256-0-51			